



#### Datasheet

## 50 A 800 V SCR in TOP3 insulated

#### **Features**

- Max. repetitive blocking voltage = V<sub>DRM</sub>, V<sub>RRM</sub> = 800 V
- I<sub>GT</sub> maximum = 80 mA
- ECOPACK<sup>®</sup>2 component (RoHS and HF compliance)
- Complies with UL 1557 standard (File ref : E81734)

#### Applications

- Solid state relays
- Welding equipment
- High power motor control
- Heating systems
- Controlled AC/DC bridge

#### **Description**

Available in a high power package TOP3-I, the BTW69-800 is suitable in applications where power handling and power dissipation are critical, such as solid state relays, welding equipment, high power motor control and power converters.

This device offers a superior performance in surge current handling capabilities, allowing usage in industrial environment.

Thanks to its internal ceramic pad, it provide high voltage insulation ( $2500V_{RMS}$ ), complying with UL standards (file ref: E81734).

LECTRO

Product status link BTW69-800

**TOP3** Isolated

Product summary					
I <sub>T(RMS)</sub>	50 A				
V <sub>DRM</sub> /V <sub>RRM</sub>	800 V				
I <sub>GT</sub>	80 mA				

# 1 Characteristics

Symbol	Parameters				Unit
I <sub>T(RMS)</sub>	RMS on-state current (180° conduction angle) $T_c = 75 \text{ °C}$				Α
IT <sub>(AV)</sub>	Average on-state current $T_c = 75 \ ^{\circ}C$ (180° conduction angle)			32	A
ITSM Non repetitive surge peak on-state current (full cycle, T <sub>i</sub> initial = 25 °C, V <sub>F</sub>		alo T initial = 25 °C $V_{\rm c}$ = 0 V/	$t_p = 8.3  \text{ms}$	610	
ITSM	Non repetitive surge peak on-state current (full cy	state current (run cycle, $T_j$ mitial – 25°C, $V_R = 0.0$ )		580	A
l <sup>2</sup> t	I <sup>2</sup> t value for fusing	t <sub>p</sub> = 10 ms, T <sub>j</sub> = 25°C		1680	A <sup>2</sup> s
dl/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$ , $t_r \le 100 \text{ ns}$ $F = 60 \text{ Hz}$		T <sub>j</sub> = 125 °C	50	A/µs
I <sub>GM</sub>	Peak gate current	t <sub>p</sub> = 20 μs	T <sub>j</sub> = 125 °C	8	Α
P <sub>G(AV)</sub>	Average gate power dissipation T <sub>j</sub> = 125 °C			1	W
T <sub>stg</sub>	Storage junction temperature range			-40 to +150	°C
Τj	Operating junction temperature range			-40 to +125	°C
V <sub>GRM</sub>	Maximum peak reverse gate voltage			5	V
V <sub>ins</sub>	Insulation RMS voltage, 1 minute			2500	V

#### Table 1. Absolute maximum ratings

## Table 2. Electrical characteristics (T<sub>j</sub> = 25°C, unless otherwise specified)

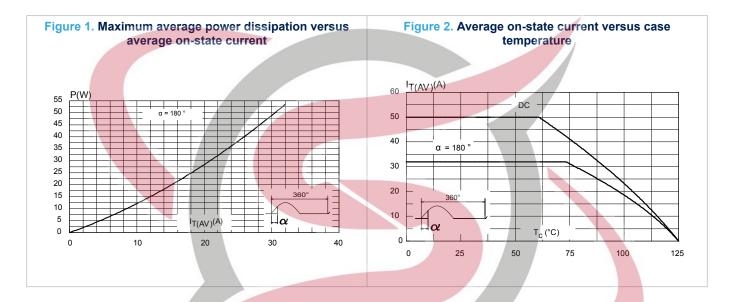
Symbol	Test conditions	Тј		Value	Unit
			Min.	8	mA
GT	$V_D$ = 12 V, $R_L$ = 33 $\Omega$	Max	80	mA	
V <sub>GT</sub>		Max	1.3	V	
V <sub>GD</sub>	$V_D = V_{DRM}, R_L = 3.3 k\Omega$	125 °C	Min.	0.2	V
IH	I <sub>T</sub> = 500 mA, gate open	Max.	150	mA	
IL	$I_{G} = 1.2 \times I_{GT}$	Max.	200	mA	
dV/dt	$V_D = 67 \%$ , $V_{DRM}$ gate open	Min.	1000	V/µs	
VTM	I <sub>TM</sub> = 100 A, t <sub>p</sub> = 380 μs	Max.	1.9	V	
V <sub>TO</sub>	Threshold on-state voltage	125 °C	Max.	1.0	V
R <sub>D</sub>	On-state dynamic resistance	Max.	8.5	mΩ	
I//	V <sub>D</sub> = V <sub>DRM</sub> , V <sub>R</sub> = V <sub>RRM</sub>	25 °C	Max.	10	μA
I <sub>DRM</sub> /I <sub>RRM</sub>	$v_D - v_{DRM}, v_R - v_{RRM}$	125 °C	ividX.	5	mA

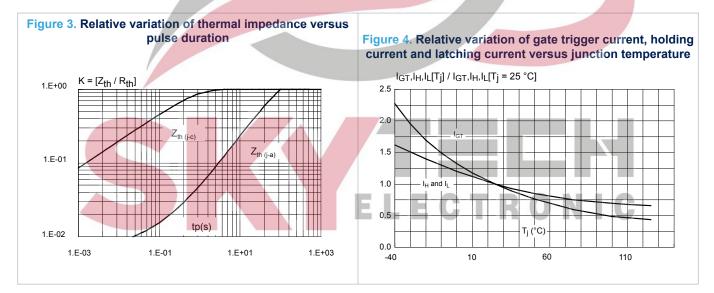
# published by WWW.SKYTECH.IR

#### Table 3. Thermal resistance

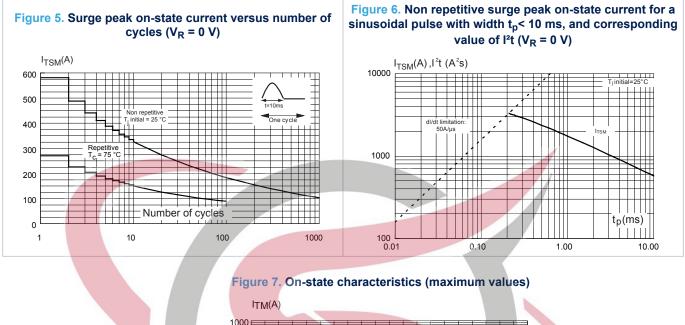
Symbol	Parameters	Value	Unit		
R <sub>th(j-c)</sub>	Junction to case (D.C)	0.9	°C 1.11		
R <sub>th(j-a)</sub>	Junction to ambiant (D.C)	50	°C/W		

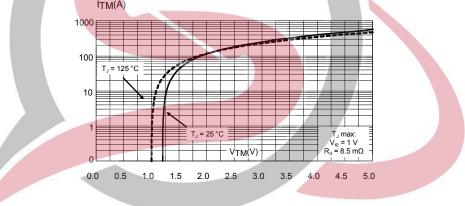
## **1.1** Characteristics (curves)

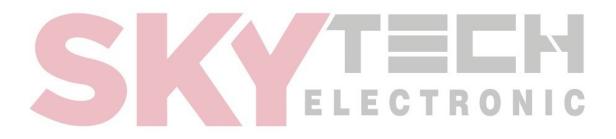












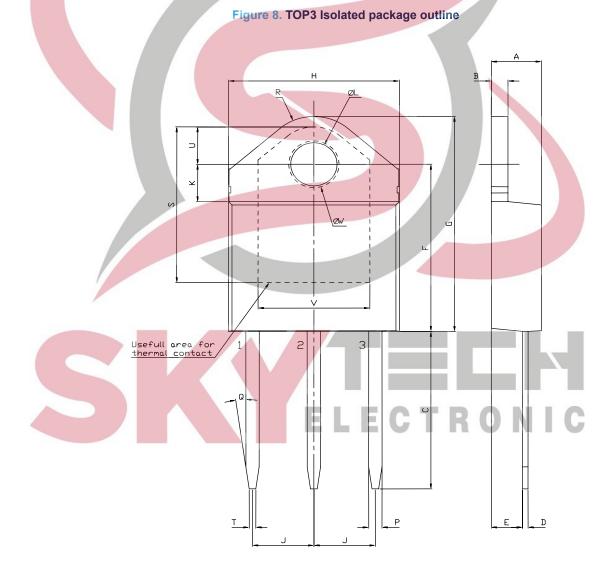
# 2 Package information

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In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

### 2.1 TOP3 Ins. package information

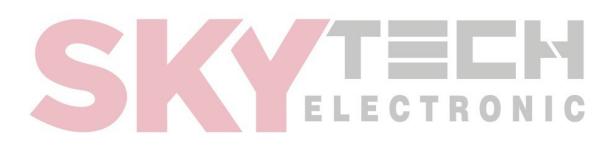
- ECOPACK® (Lead-free plating and Halogen free package compliance)
- Lead-free package leads finishing
- Halogen-free molding compound resin meets UL94 standard level V0
- Recommended torque: 1.05 N·m (max. torque: 1.2 N·m).



	Dimensions					
Ref.	mm			Inches <sup>(1)</sup>		
	Min.	Тур.	Max.	Min.	Тур.	Max.
А	4.40		4.60	0.1732		0.1811
В	1.45		1.55	0.0571		0.0610
С	14.35		15.60	0.5650		0.6142
D	0.50		0.70	0.0197		0.0276
E	2.70		2.90	0.1063		0.1142
F	15.80		16.50	0.6220		0.6496
G	20.40		21.10	0.8031		0.8307
Н	15.10		15.50	0.5945		0.6102
J	5.40		5.65	0.2126		0.2224
к	3.40		3.65	0.1339		0.1437
L	4.08		4.17	0.1606		0.1642
М	1.20		1.40	0.0472		0.0551
R		4.60			0.1811	

Table 4. TOP3 Isolated mechanical data

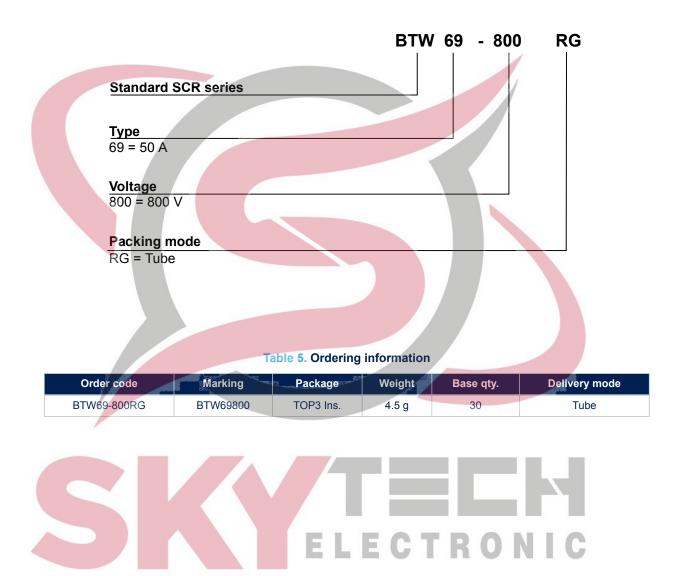
1. Inches given for reference only





## **3** Ordering information

#### Figure 9. Ordering information scheme



## **Revision history**

Date	Revision	Changes
09-Sep-2019	1	Initial release.





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